

# **BT151X series**

### **Thyristors**

Rev. 04 — 9 June 2004

**Product data sheet** 



#### 1.1 General description

Passivated thyristors in a SOT186A full pack plastic package.

#### 1.2 Features

- High thermal cycling performance
- High bidirectional blocking voltage capability
- Isolated mounting base.

### 1.3 Applications

Motor control

Industrial and domestic lighting, heating and static switching.

#### 1.4 Quick reference data

- $V_{DRM}$ ,  $V_{RRM} \le 800 \text{ V (BT151X-800)}$
- $V_{DRM}$ ,  $V_{RRM} \le 650 \text{ V (BT151X-650)}$
- $V_{DRM}$ ,  $V_{RRM} \le 500 \text{ V (BT151X-500)}$
- $I_{T(RMS)} \le 12 A$
- $I_{T(AV)} \le 7.5 \text{ A}$
- I<sub>TSM</sub>  $\leq$  120 A.

## 2. Pinning information

Table 1: Discrete pinning

Pin	Description	Simplified outline	Symbol
1	cathode (k)		
2	anode (a)	mb	7
3	gate (g)	000	sym037
mb	mounting base; isolated		
		SOT186A (TO-220)	





## 3. Ordering information

**Table 2: Ordering information** 

Type number	Package		
	Name	Description	Version
BT151X-500	· <b>-</b>	plastic single-ended package; isolated heatsink mounted; 1 mounting hole;	
BT151X-650		3 lead TO-220 'full pack'	
BT151X-800			

## 4. Limiting values

Table 3: Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

Symbol	Parameter	Conditions	N	/lin	Max	Unit
$V_{DRM},V_{RRM}$	repetitive peak off-state voltage					
	BT151X-500		<u>[1]</u> _		500	V
	BT151X-650		[1]		650	V
	BT151X-800		-		800	V
$I_{T(AV)}$	average on-state current	half sinewave; T <sub>hs</sub> ≤ 69 °C; <u>Figure 1</u>	-		7.5	Α
I <sub>T(RMS)</sub>	RMS on-state current	all conduction angles; Figure 4 and Figure 5	-		12	Α
I <sub>TSM</sub>	non-repetitive peak on-state current	half sinewave; $T_j = 25$ °C prior to surge; Figure 2 and Figure 3				
		t = 10 ms	-		120	Α
		t = 8.3 ms	-		132	Α
l <sup>2</sup> t	I <sup>2</sup> t for fusing	t = 10 ms	-		72	A <sup>2</sup> s
dl <sub>T</sub> /dt	repetitive rate of rise of on-state current after triggering	$I_{TM}$ = 20 A; $I_{G}$ = 50 mA; $dI_{G}/dt$ 50 mA/ $\mu$ s	-		50	A/μs
I <sub>GM</sub>	peak gate current		-		2	Α
$V_{RGM}$	peak reverse gate voltage		-		5	V
P <sub>GM</sub>	peak gate power		-		5	W
P <sub>G(AV)</sub>	average gate power	over any 20 ms period	-		0.5	W
T <sub>stg</sub>	storage temperature		_	-40	+150	°C
T <sub>j</sub>	junction temperature		-		125	°C

<sup>[1]</sup> Although not recommended, off-state voltages up to 800 V may be applied without damage, but the thyristor may switch to the on-state. The rate of rise of current should not exceed 15 A/ $\mu$ s.

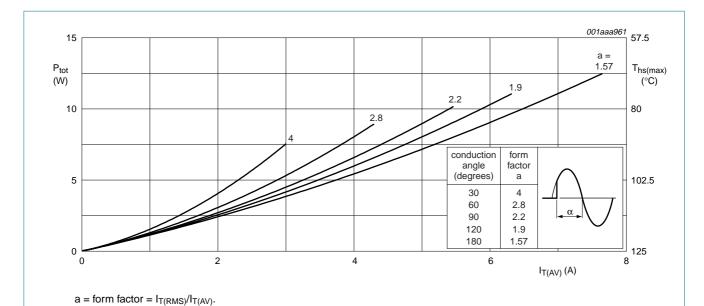
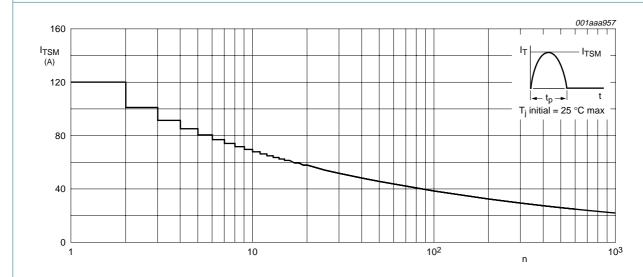


Fig 1. Total power dissipation as a function of average on-state current; maximum values.



f = 50 Hz.

Fig 2. Non-repetitive peak on-state current as a function of the number of sinusoidal current cycles; maximum values.

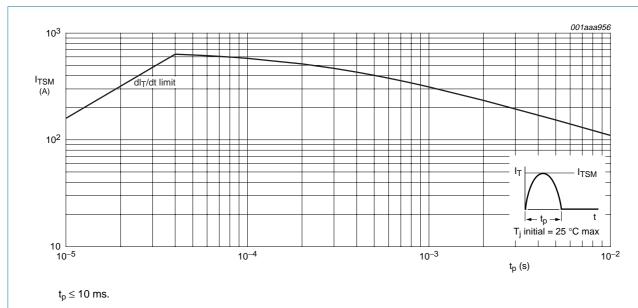


Fig 3. Non-repetitive peak on-state current as a function of pulse width; maximum values.

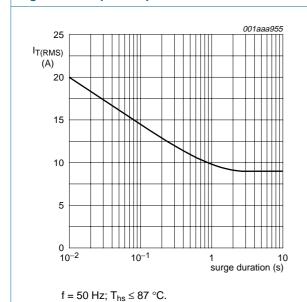


Fig 4. RMS on-state current as a function of surge duration; maximum values.

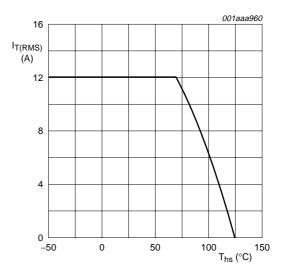


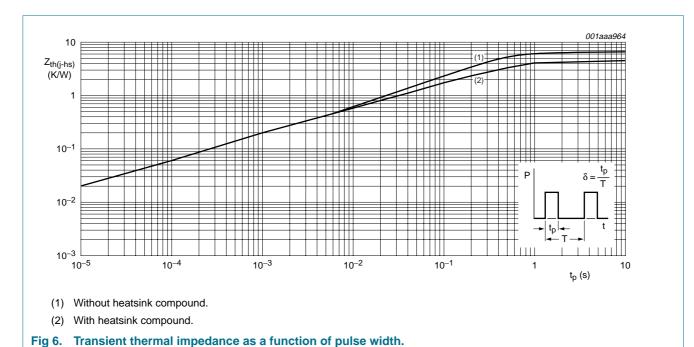
Fig 5. RMS on-state current as a function of heatsink temperature; maximum values.



### 5. Thermal characteristics

Table 4: Thermal characteristics

Symbol	Parameter	Conditions	Тур	Max	Unit
$R_{th(j-hs)}$	thermal resistance from	Figure 6			
	junction to heatsink	with heatsink compound	-	4.5	K/W
		without heatsink compound	-	6.5	K/W
$R_{th(j-a)}$	thermal resistance from junction to ambient	in free air	55	-	K/W



#### 6. Isolation characteristics

### Table 5: Isolation limiting values and characteristics

T<sub>hs</sub> = 25 °C unless otherwise specified

Symbol	Parameter	Conditions	Тур	Max	Unit
V <sub>isol</sub>	RMS isolation voltage from all three terminals to external heatsink	$f$ = 50 to 60 Hz; sinusoidal waveform; R.H. $\leq$ 65%; clean and dust free	-	2500	V
C <sub>isol</sub>	capacitance from pin 2 to external heatsink	f = 1 MHz	10	-	pF



### 7. Characteristics

Table 6: Characteristics

 $T_i = 25 \,^{\circ}C$  unless otherwise stated

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
Static cha	racteristics					
I <sub>GT</sub>	gate trigger current	V <sub>D</sub> = 12 V; I <sub>T</sub> = 0.1 A; <u>Figure 8</u>	-	2	15	mA
IL	latching current	V <sub>D</sub> = 12 V; I <sub>GT</sub> = 0.1 A; <u>Figure 10</u>	-	10	40	mA
I <sub>H</sub>	holding current	V <sub>D</sub> = 12 V; I <sub>GT</sub> = 0.1 A; <u>Figure 11</u>	-	7	20	mA
V <sub>T</sub>	on-state voltage	I <sub>T</sub> = 23 A; <u>Figure 9</u>	-	1.4	1.75	V
$V_{GT}$	gate trigger voltage	V <sub>D</sub> = 12 V; I <sub>T</sub> = 0.1 A; <u>Figure 7</u>	-	0.6	1.5	V
		$V_D = V_{DRM(max)}; I_T = 0.1 A;$ $T_j = 125 ^{\circ}C$	0.25	0.4	-	V
I <sub>D</sub> , I <sub>R</sub>	off-state leakage current	$V_D = V_{DRM(max)}$ ; $V_R = V_{RRM(max)}$ ; $T_j = 125  ^{\circ}C$	-	0.1	0.5	mA
Dynamic o	haracteristics					
dV <sub>D</sub> /dt	critical rate of rise of off-state voltage	$V_{DM} = 67\% V_{DRM(max)}; T_j = 125 °C;$ exponential waveform; Figure 12				
		gate open circuit	50	130	-	V/μs
		R <sub>GK</sub> = 100 Ω	200	1000	-	V/μs
t <sub>gt</sub>	gate controlled turn-on time	$I_{TM} = 40 \text{ A}; V_D = V_{DRM(max)};$ $I_G = 0.1 \text{ A}; dI_G/dt = 5 \text{ A/}\mu\text{s}$	-	2	-	μs
t <sub>q</sub>	circuit commuted turn-on time	$V_D$ = 67% $V_{DRM(max)}$ ; $T_j$ = 125 °C; $I_{TM}$ = 20 A; $V_R$ = 25 V; $dI_{TM}/dt$ = 30 A/μs; $dV_D/dt$ = 50 V/μs; $R_{GK}$ = 100 $\Omega$	-	70	-	μs

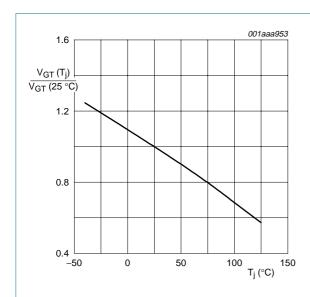


Fig 7. Normalized gate trigger voltage as a function of junction temperature.

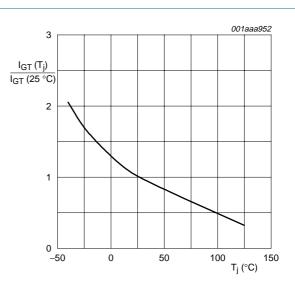
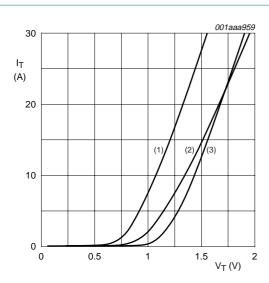


Fig 8. Normalized gate trigger current as a function of junction temperature.

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 $V_O = 1.06 \text{ V}.$   $R_S = 0.0304 \ \Omega.$ 

- (1)  $T_i = 125 \,^{\circ}\text{C}$ ; typical values.
- (2)  $T_j = 125$  °C; maximum values.
- (3)  $T_i = 25 \,^{\circ}C$ ; maximum values.

Fig 9. On-state current characteristics.

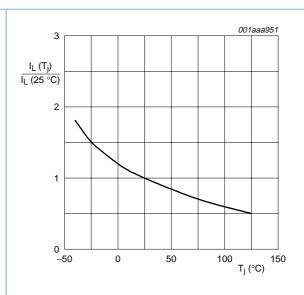


Fig 10. Normalized latching current as a function of junction temperature.

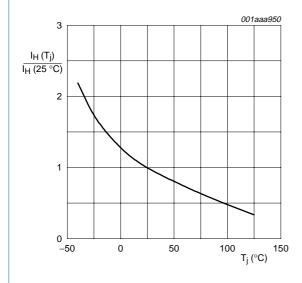
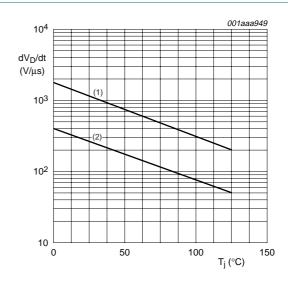


Fig 11. Normalized holding current as a function of junction temperature.



- (1)  $R_{GK} = 100 \Omega$ .
- (2) Gate open circuit.

Fig 12. Critical rate of rise of off-state voltage as a function of junction temperature; minimum values.

## 8. Package information

Epoxy meets requirements of UL94 V-0 at ½ inch.

**Product data sheet** 

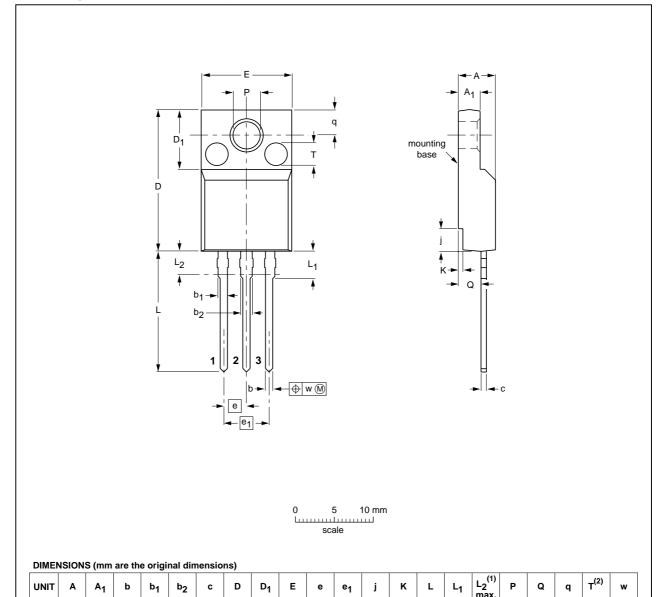
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Plastic single-ended package; isolated heatsink mounted;

1 mounting hole; 3 lead TO-220 'full pack'

SOT186A



#### Notes

1. Terminal dimensions within this zone are uncontrolled. Terminals in this zone are not tinned.

15.8

6.5 10.3

2. Both recesses are  $\varnothing$  2.5  $\times$  0.8 max. depth

0.9

1.0 0.4

OUTLINE		REFER	ENCES	EUROPEAN	ISSUE DATE
VERSION	IEC	JEDEC	JEITA	PROJECTION	ISSUE DATE
SOT186A		3-lead TO-220F			<del>02-03-12</del> 02-04-09

2.54

5.08

3.30 2.79

14.4

13.5

0.4

Fig 13. Package outline.

4.6

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2.5 0.4

Thyristors



# 10. Revision history

### Table 7: Revision history

Document ID	Release date	Data sheet status	Change notice	Order number	Supersedes
BT151X_SERIES_4	20040609	Product specification	-	9397 750 13162	BT151X_SERIES_3
Modifications:		t of this specification has on and information stand	•	omply with Philips	Semiconductors' new
BT151X_SERIES_3	20030901	Product specification	-	-	BT151X_SERIES_2
BT151X_SERIES_2	19990601	Product specification	-	-	BT151X_SERIES_1
BT151X_SERIES_1	19970901	Product specification	-	-	-

**Thyristors** 



Level	Data sheet status [1]	Product status [2] [3]	Definition
I	Objective data	Development	This data sheet contains data from the objective specification for product development. Philips Semiconductors reserves the right to change the specification in any manner without notice.
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Limiting values definition — Limiting values given are in accordance with the Absolute Maximum Rating System (IEC 60134). Stress above one or more of the limiting values may cause permanent damage to the device. These are stress ratings only and operation of the device at these or at any other conditions above those given in the Characteristics sections of the specification is not implied. Exposure to limiting values for extended periods may affect device reliability.

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## **Philips Semiconductors**

# **BT151X series**

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